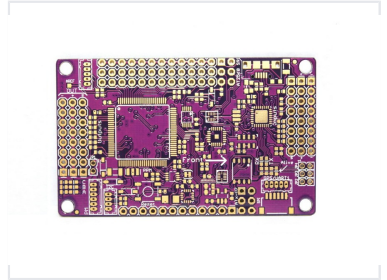


Multilayer Printed Circuit Board with Purple Soldermask

This is a multilayer printed circuit board (PCB) with a purple soldermask. The board is designed for complex electronic circuits and high-density component placement.



Product Overview

High-Performance 6-Layer Multilayer PCB

This advanced 6-layer multilayer printed circuit board features a professional purple soldermask and high-durability FR4 TG170 material. Designed for complex signal routing and reliable performance, the board includes high-quality ENIG surface finishing to ensure excellent conductivity and oxidation resistance. It is an ideal solution for prototyping, development, and high-density electronic assemblies requiring robust power management and communication interfaces.

Technical Specifications

Number of Layers	6
Base Material	FR4 TG170
Board Thickness	1.6 mm
Finish Copper Weight	35/35 µm

Manufacturing Capabilities

Minimum Width/Space	0.075 mm
Finished Hole Size	0.25 mm

Surface Treatment

Surface Finish	ENIG
Soldermask Color	Purple